

# SOT730-1

ceramic window quad chip carrier; no leads; with lens; body  
10.7 x 10.7 x 8 mm

8 February 2016

Package information

## 1. Package summary

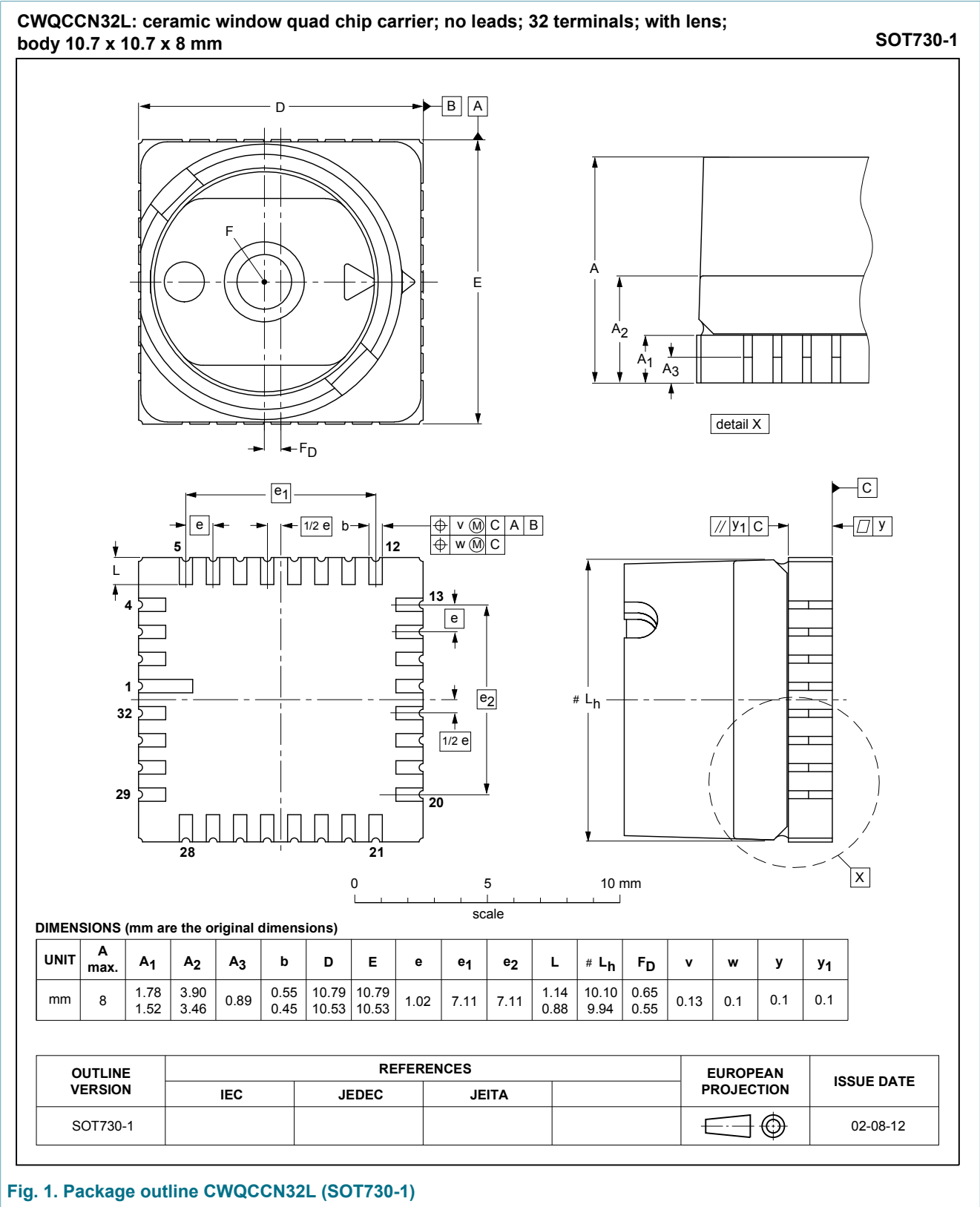
Terminal position code	Q (quad)
Package type descriptive code	CWQCCN32L
Package type industry code	CWQCCN32L
Package style descriptive code	CWQCCN (ceramic window quad chip carrier; no leads)
Package style suffix code	NA (not applicable)
Package body material type	C (ceramic)
Mounting method type	S (surface mount)
Issue date	12-8-2002

Table 1. Package summary

Symbol	Parameter		Min	Typ	Nom	Max	Unit
D	package length		10.53	-	10.7	10.79	mm
E	package width		10.53	-	10.7	10.79	mm
A	seated height		8	-	8	8	mm
A <sub>2</sub>	package height		3.46	-	3.68	3.9	mm
n <sub>2</sub>	actual quantity of termination		-	-	32	-	



2. Package outline



ceramic window quad chip carrier; no leads; with  
lens; body 10.7 x 10.7 x 8 mm

### 3. Legal information

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